

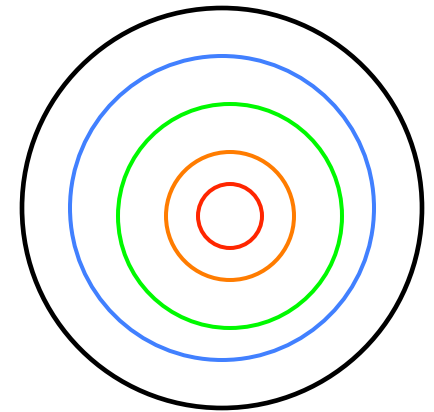
## Real Plasma with $n, T \sim p$

Equilibrium: 
$$\nabla p = \mathbf{j} \times \mathbf{B}$$

B lines must lie in isobaric surfaces.

Since  $\nabla \cdot \mathbf{B} = 0$ , only possible if isobaric surfaces are topological tori. Magnetic field lines must form nested tori.

Equilibrium **must** also be stable. **Much** more complex considerations (Shafranov), established that the only **stable, toroidally-symmetric** equilibria must have a toroidal plasma **current** in addition to the **toroidal magnetic field**, a tokamak.



*Note that the magnetic field lines in the nested surfaces, Isobars resulting from the combination of toroidal field and the field from the plasma current, will be helices.*

# Macroscopic plasma measurements (for almost any magnetically confined plasma)

- I. Magnetic fields, surfaces (Time-dependent)
- II. Currents (Time-dependent in **closed** loops)
- III. Voltages (Around **closed** loops)

Standard circuit theory approaches useless  
No “network” approximation

# Magnetic pickup coils

- Applying Faraday's Law

$$\oint \vec{E} \cdot d\vec{l} = - \int_S \dot{\vec{B}} \cdot d\vec{s}$$

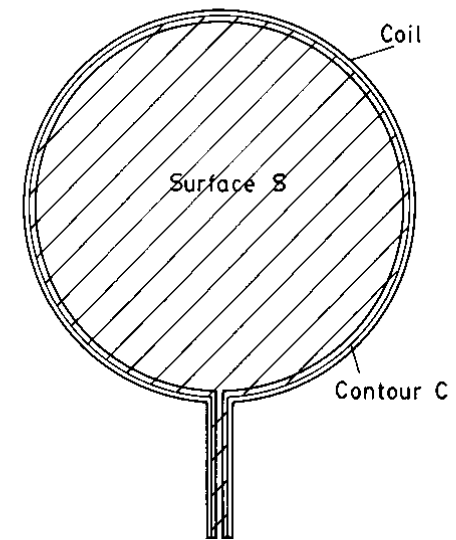
- The contour integral of electric field

$$\oint_C \vec{E} \cdot d\vec{l} = \oint_{coil} \vec{E} \cdot d\vec{l} + \oint_{ends} \vec{E} \cdot d\vec{l} = - \int_S \dot{\vec{B}} \cdot d\vec{s}$$

0

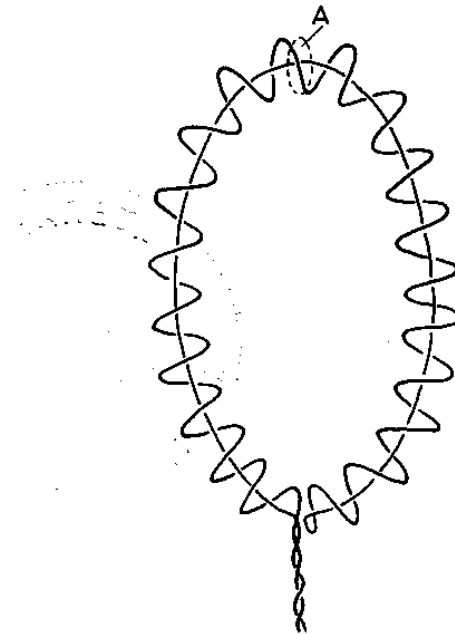
- The coil measures the mean value of B normal to coil
- Surface integral spans space between leads. Twist or shield leads to minimize contribution
- Need adequate input impedance for detector ( $R/L > v_{\text{maxresponse}}$ )
- Use analog or digital integration for B(t)

12 *Magnetic diagnostics*



# Measuring current I

- The plasma current can be measured by a Rogowski coil, which is a linear multiturn solenoidal coil whose ends are brought together to form a loop. Can be looped around any conductor.
- Coils should have uniform cross section  $A$  and have  $n$  turns/unit length. (Wound on cylinder.)
- Signal does not depend on current distribution, to a good approximation
- Frequency response from coil  $L$  and detector  $R$ .



# Measuring current II

- Total flux linkage can be written as an integral rather than a sum over individual terms ( $dN=ndl$ )

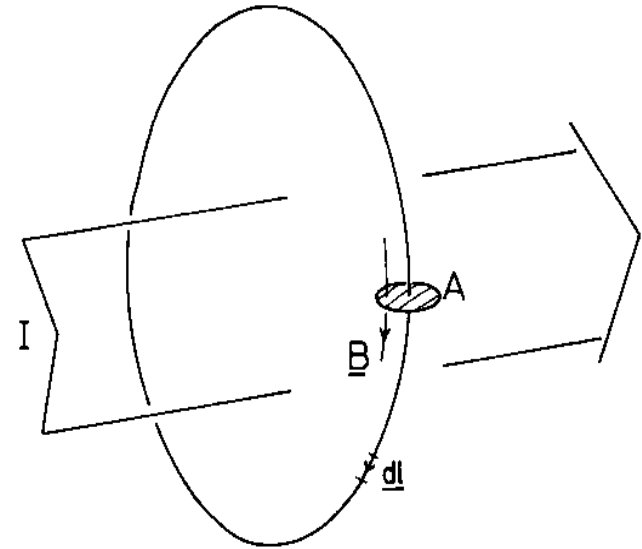
$$\dot{\Phi} = n \oint_l \int_A dA \dot{\mathbf{B}} \cdot d\mathbf{l}$$

- Amperes law gives

$$\oint B \cdot d\mathbf{l} = \mu_o I$$

- The voltage out of a Rogowski coil is thus

$$V = \dot{\Phi} = nA\mu_o \dot{I}$$



The signal can be integrated passively, actively, or digitally.

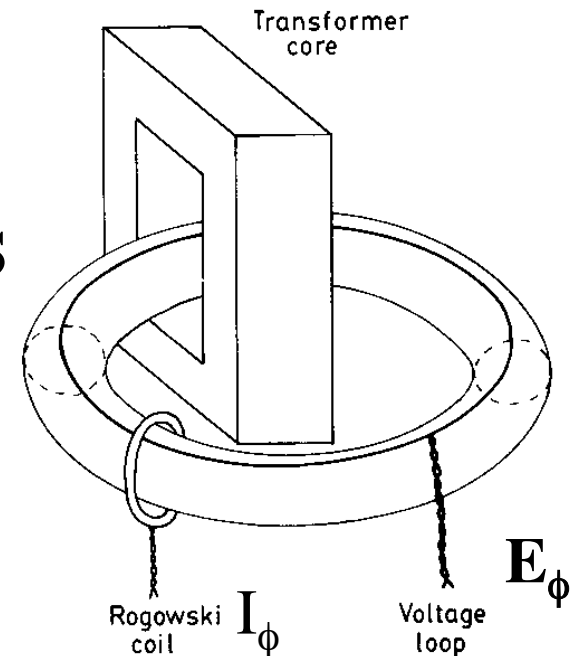
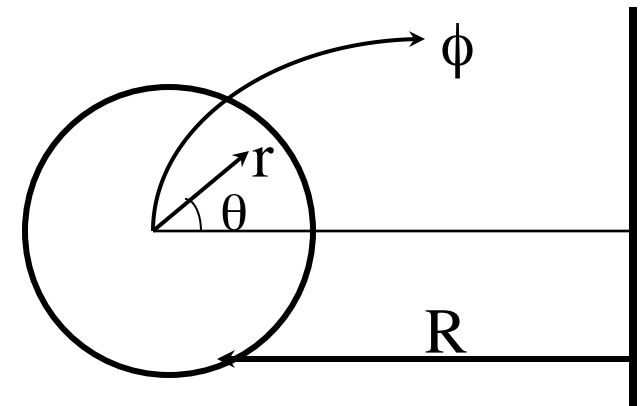
# Application to a tokamak -- Global

- Objective: Calculate Ohmic power input into the plasma.
- Write Poynting's theorem as applied to a volume  $V$  bounded by a toroidal surface  $S$ , vacuum vessel, where the measuring loops are placed.

$$\int_V \left[ \mathbf{E} \cdot \mathbf{j} + \frac{1}{2\mu_0} \frac{\partial}{\partial t} (B_\theta^2) \right] d^3x = -\frac{1}{\mu_0} \oint_S (\mathbf{E} \times \mathbf{B}) \cdot d\mathbf{S}$$

$$B_\theta \propto I_\phi = I_{\text{plasma}}$$

Time derivative only during current changes.



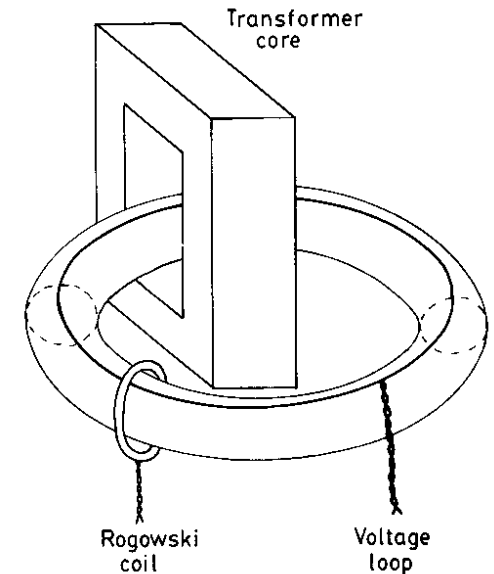
# Tokamak II -- Global

We can write the energy equation as

$$P \equiv \int_V \mathbf{E} \cdot \mathbf{j} d^3x \cong \iiint R d\phi E_\phi j_\phi r dr d\theta = V_\phi I_\phi - \frac{\partial}{\partial t} \left( \frac{1}{2} L I_\phi^2 \right)$$

where the inductance is  $L \equiv \frac{1}{\mu_o I_\phi^2} \int_V B_\theta^2 d^3x$

and  $V_\phi \cong 2\pi R E_\phi$ , simple measurements for the power input. Note L depends on the distribution of the toroidal current density.



Using Ohm's law as  $j_\phi = \sigma E_\phi$ , where both  $j_\phi$  and  $\sigma$  depend strongly on minor radius  $r$ , the plasma current can also be written as

$$I_\phi = \int d\theta \int_0^a j_\phi r dr = \int d\theta \int_0^a \sigma r dr E_\phi = \pi a^2 \langle \sigma \rangle E_\phi \quad \text{and}$$

$$V_\phi = V_{loop} = \frac{1}{\langle \sigma \rangle} \frac{2R}{a^2} I_\phi \equiv R_{plasma} I_{plasma}$$

Plasma resistance as an average conductivity

# Tokamak III -- Internal

Although the basic calculation is usually for  $\sigma$  as  $\langle v \rangle \propto E$ , it is more often given as resistivity  $\eta$  and credited to Spitzer for the proper combination of the Rutherford cross-section with the screening of the  $1/r$  potential at the Debye length by the plasma:

$$\eta = \frac{m v_c}{n e^2} = 5.2 \times 10^{-5} \frac{Z_{\text{eff}} \ln \Lambda}{T_e^{3/2}} [\Omega - m]$$

where  $Z_{\text{eff}}$  is a mean ion charge for complex plasmas. With two circuits to measure current and loop voltage, we have an estimate of (mean electron) temperature. The quantity  $\Lambda$  is approximately the ratio of the Debye length to the impact parameter for  $90^\circ$  scattering. For  $T_e > 10$  eV

$$\ln \Lambda \cong 31 - \ln \left( n_e^{1/2} / T_{eV} \right) \quad \ln \Lambda \sim 15 \text{ for hot plasmas}$$



# Tokamak IV -- Internal

## Nested flux surfaces

Where is the center (magnetic axis)?

What is shape and position of outermost (not touching vessel) one?

Even for the (symmetric) tokamak, solving  $\nabla p = \mathbf{j} \times \mathbf{B}$  is a very difficult problem theoretically and computationally, and inferring the solution from experiment is equally demanding.

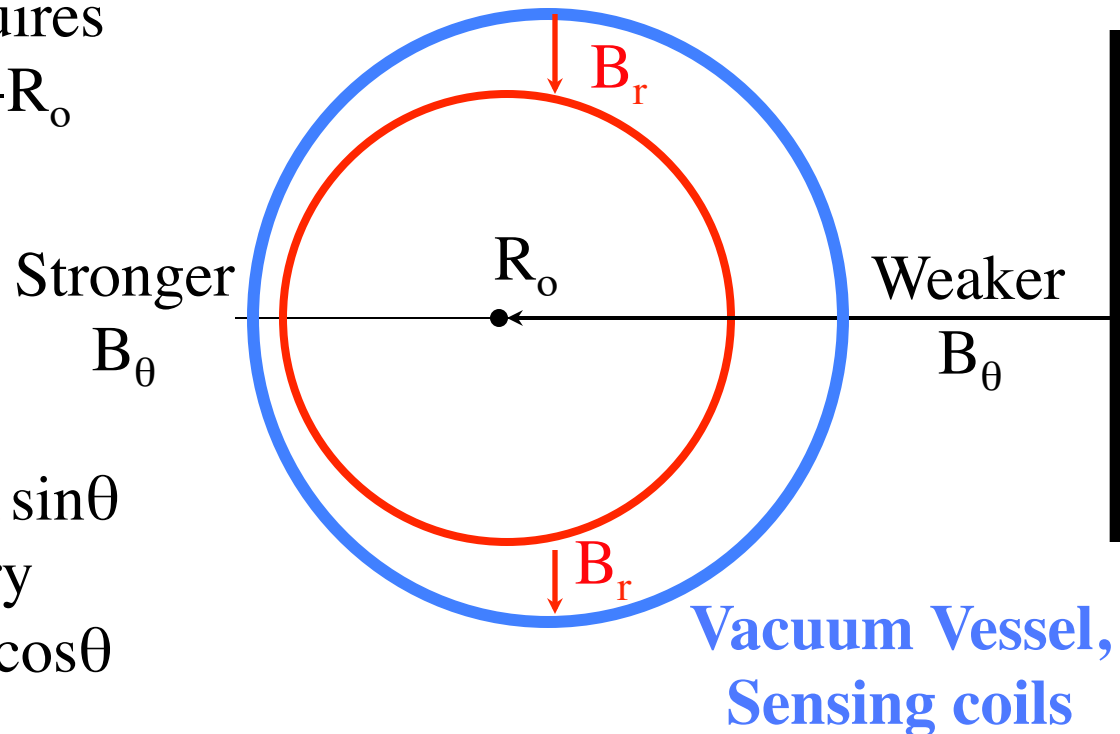
The scope of the problem can be appreciated by considering the simplest case -- a tokamak with a toroidal field, a plasma current, and no other significant contributors to  $\mathbf{B}$  (unlike any modern tokamak). As might be expected, the nested flux surfaces have circular cross-sections. The primary quantities of importance are only the positions of the axis and outermost flux surface:

$$\mathbf{R}_A, \mathbf{z}_A, \mathbf{a}, \mathbf{R}_o, \mathbf{z}_o$$

# Center of Outermost (last) surface

MHD equilibrium requires  
 $z_o = z_A$  and value of  $R_A - R_o$

Magnetic flux surface,  
 Lines of " $B_\theta$ "



$$\Delta R: \Delta B_\theta \cos\theta; \Delta B_r \sin\theta$$

and by symmetry

$$\Delta z: \Delta B_\theta \sin\theta; \Delta B_r \cos\theta$$

From a set of coils specifically constructed to measure  $I_p$  and the sine and cosine components of  $B_r$  and  $B_\theta$ , one can determine the position of the center of the outermost flux surface and, with less accuracy,  $R_A - R_o$ .

## Magnetic Axis $R_A, z_A$

- I. From the (four) magnetic measurements used to find  $R_o, z_o$ , one can also infer  $\Delta_S$  -- Shafronov shift -- the difference between  $R_o$  and  $R_A(z_o = z_A)$ .
- II. From radiation measurements, either transmitted or emitted, one can infer the center (magnetic axis). These are all chord-integrated,  $\int dl$ , and the values are generally maximum for the chord through the axis because the integrand is maximal on axis. Emission of energetic radiation, typically x-rays  $\sim 1\text{keV}$ , occurs only near the axis because only there is the temperature high enough and the result is strongly peaked for the chord through the axis.

# Gross Plasma Containment

## Beyond MHD -- “Transport”

- Energy

$$W_{Loss} = \frac{E}{\tau_E} = W_{IN} - \frac{dE}{dt}$$

$W_{IN}$  is (measured)  
power input  
 $E$  is (measured)  
energy content

$\tau_E \equiv$  energy confinement time (generally well-known)

- Particles

$$F_{Loss} = \frac{N}{\tau_P} = F_{IN} - \frac{dN}{dt}$$

$F_{IN}$  is (unknown)  
particle source

$\tau_P \equiv$  particle containment time  
(poorly determined)

# Quantitative Plasma Confinement

- Conservation Laws  $\frac{\partial X}{\partial t} = -\nabla \cdot Flux_X$
- Plasma approximately uniform ( $n$ ,  $T$ , etc.) on a magnetic surface
- Parameters vary in perpendicular “radial” direction
- Particles:  $n_s$ ,  $\Gamma_{s,r} = -D_s \frac{\partial n_s}{\partial r} + V_s n_s$
- Energy:  $(3/2)n_s T_s \Rightarrow \frac{3}{2} \frac{\partial T_s}{\partial t} = \nabla_r \cdot \left( \chi_s \frac{\partial T_s}{\partial r} \right)$

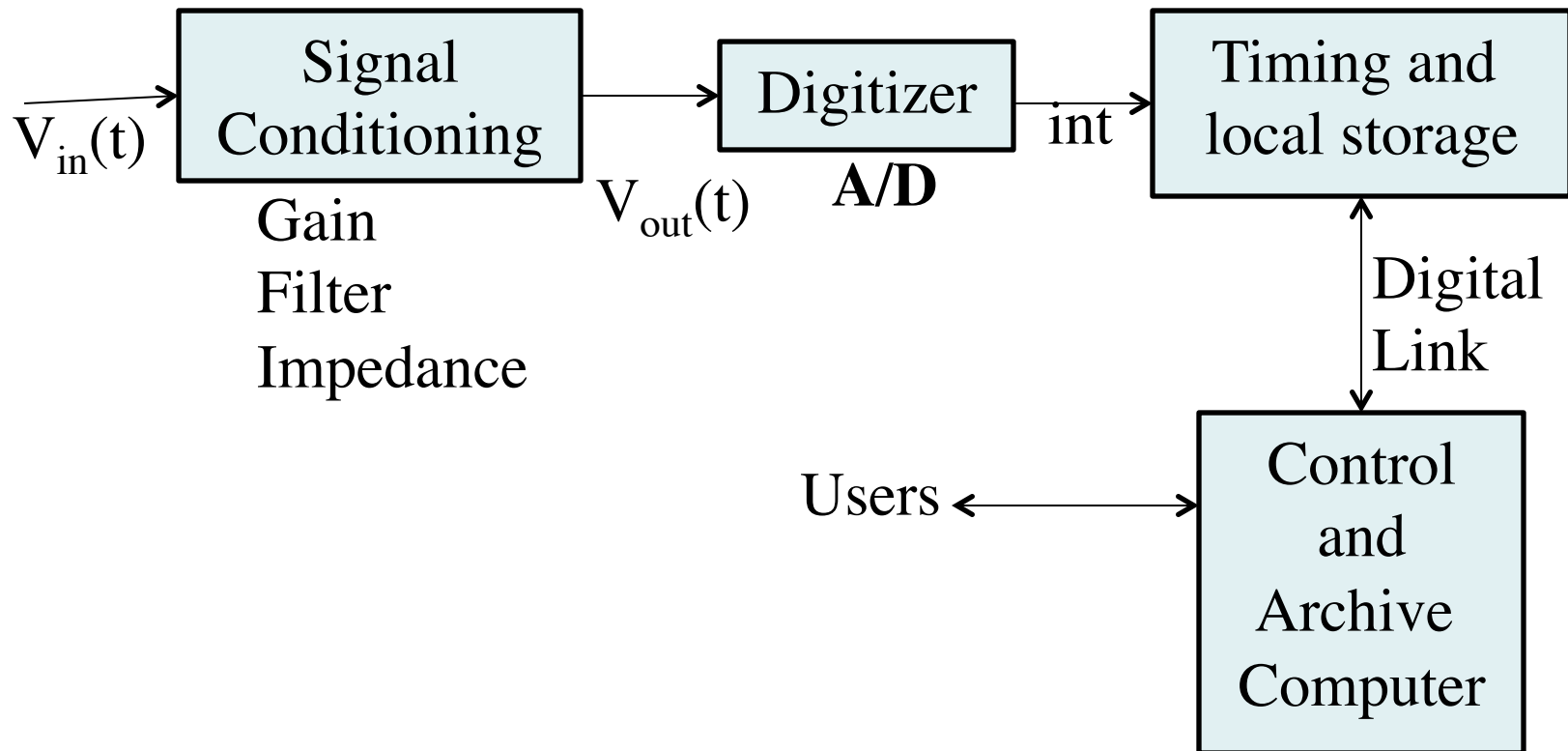
Objective: Measure and understand the transport coefficients, which are different for electrons and each ion species and also include (vector) momentum.

# Digital Signal Acquisition and Processing

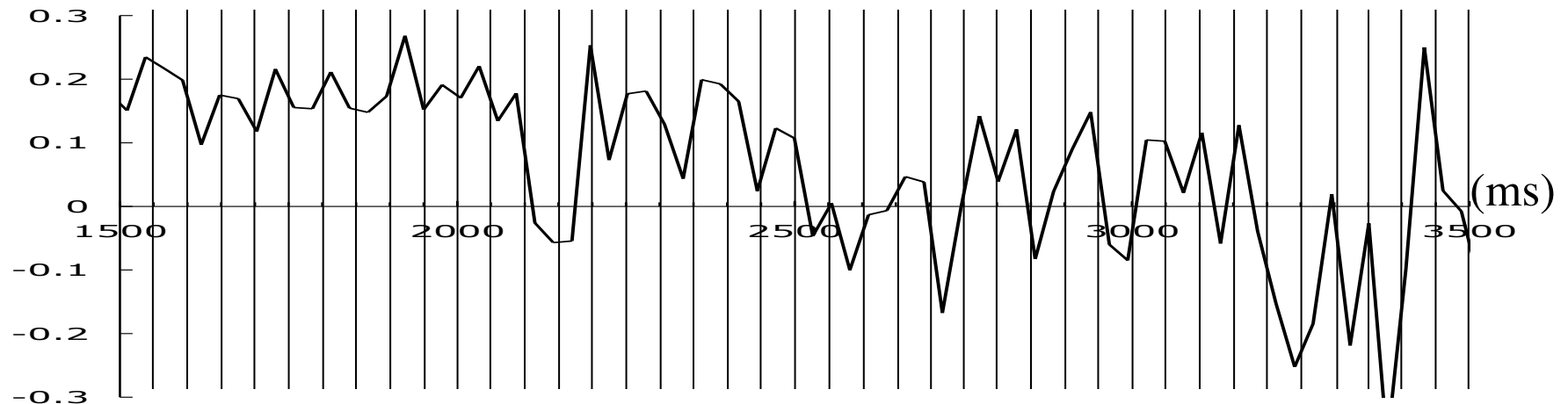
- An essential tool for experimental physics
- Used for one-dimensional or multi-dimensional (image) data
- Consider the basic general principles for one-dimensional data --  $S(t)$
- Use for higher dimensions also quite common but specific to application

# Digital Signal Acquisition and Processing

## Components of a System



# Digital Signal Acquisition and Processing

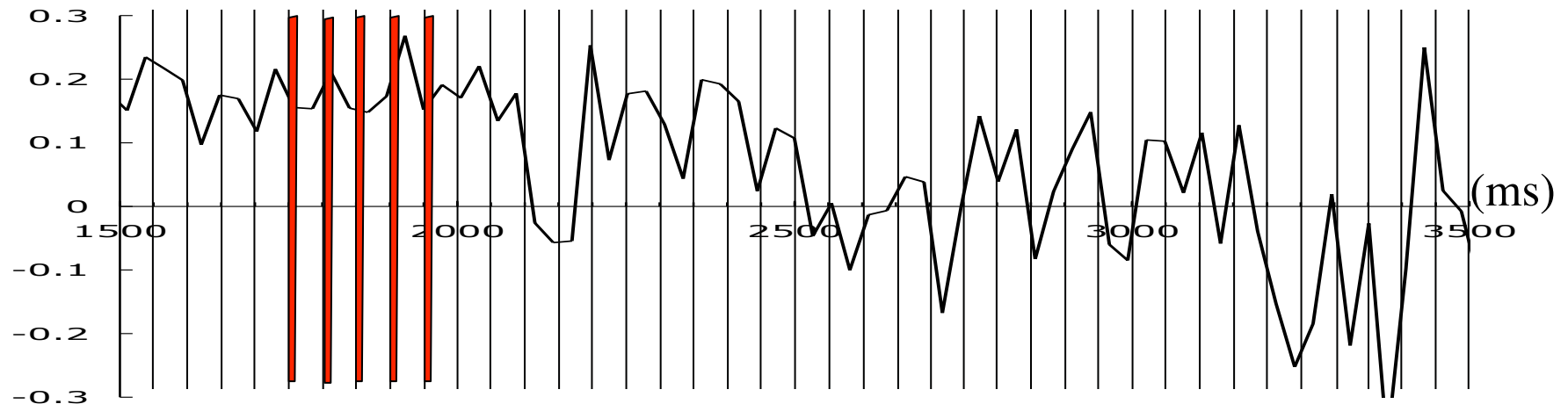


Sample data periodically, here every 5 ms,  
a rate of 200 samples/sec

- What happens next?
- NOT what you might expect!



# Digital Signal Acquisition and Processing



Interval between samples 5 ms / Sampling frequency 200/sec

Sampling Time 0.2 ms (“Sample and hold”)

Consequences:

- ALIASING – e.g. a signal at 200 Hz appears as a dc signal; 240 Hz appears at 40Hz!
- Poor phase, amplitude data for  $v$  near sampling  $v$

# A/D System Design Requirements

- $v_{\text{Samp}} \geq 5v_{\text{Data}}$  and  $v_{\text{Samp}} \gg v_{\text{Phase}}$
- Signal conditioning -6 db at  $v_{\text{Samp}}$  and adequate to charge  $C_{\text{in}}$  of sample and hold in brief sample  $\tau^*$
- Keep  $|V_{\text{max}}|$  below A/D rating – A/Ds NOT tolerant
- Check digitizer bits (14 bit, 16 bit, etc.);  $|V_{\text{min}}|$  should correspond to 4-6 bits to keep resolution
- Total Memory capacity adequate to application

**These conflicting demands generally require specific A/D systems for each application.**

\* Depends somewhat on whether one A/D per channel or a single A/D switched between channels

# Advantages of A/D & Computer Systems

- Ease of acquisition, annotation, storage, display, retrieval, and backup
- Highly accurate values and timing
- Complete flexibility in analysis and reanalysis
- Natural data sharing and collaboration

**These account for its near-universal use**

# Disadvantages of A/D & Computer Systems

- High “overhead” in creating and maintaining hardware and software
- Output sometimes misleading: GIGO, misrepresentation of input signal & aliasing, “manufactured” precision
- Lack of robust, versatile electronics
- Limited open-sourced resources
- **Overuse of proprietary software**; “rented” results from temporary licenses may vanish